MARKING



TinyLogic UHS Two-Input AND Gate

NC7SZ08

Description

The NC7SZ08 is a single two-input AND gate from **onsemi's** Ultra–High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra–high speed with high output drive while maintaining low static power dissipation over a broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65 V to 5.5 V $V_{\rm CC}$ operating range. The inputs and output are high impedance when $V_{\rm CC}$ is 0 V. Inputs tolerate voltages up to 5.5 V, independent of $V_{\rm CC}$ operating voltage.

Features

- Ultra-High Speed: t_{PD} = 2.7 ns (Typical) into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX Operated at 3.3 V V_{CC}
- Power Down High Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPakTM Packages
- Space–Saving SOT23–5, SC–74A and SC–88A Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



Figure 1. Logic Symbol

1

DIAGRAMS GGKK SIP6 CASE 127EB XYZ **UDFN6 GGKK** CASE 517DP XYZ SC-74A 7Z08 M• **CASE 318BQ** 0 SOT23-5 7Z08 M CASE 527AH SC-88A Z08 M• CASE 419A-02

GG, 7Z08, Z08 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code
XY = 2-Digit Date Code Format
Z = Assembly Plant Code

M = Date Code

= Pb-Free Package

(Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

Pin Configurations

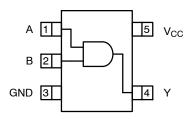


Figure 2. SOT23-5, SC-88A and SC-74A (Top View)

A 1 6 V_{CC} B 2 5 NC GND 3 4 Y

Figure 3. MicroPak (Top Through View)

PIN DEFINITIONS

| Pin # SOT23-5 / SC-88A / SC74A | Pin # MicroPak | Name | Description |
|---|----------------|-----------------|----------------|
| 1 | 1 | Α | Input |
| 2 | 2 | В | Input |
| 3 | 3 | GND | Ground |
| 4 | 4 | Υ | Output |
| 5 | 6 | V _{CC} | Supply Voltage |
| | 5 | NC | No Connect |

FUNCTION TABLE (Y = AB)

| Inp | Output | |
|-----|--------|---|
| Α | В | Υ |
| L | L | L |
| L | Н | L |
| Н | L | L |
| Н | Н | Н |

H = HIGH Logic Level L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

| Symbol | Param | eter | Min | Max | Unit |
|-------------------------------------|--------------------------------------|------------------------|------|------|------|
| V _{CC} | Supply Voltage | | -0.5 | 6.5 | V |
| V _{IN} | DC Input Voltage | | -0.5 | 6.5 | V |
| V _{OUT} | DC Output Voltage | | -0.5 | 6.5 | V |
| I _{IK} | DC Input Diode Current | V _{IN} < 0 V | - | -50 | mA |
| l _{OK} | DC Output Diode Current | V _{OUT} < 0 V | - | -50 | mA |
| I _{OUT} | DC Output Current | | - | ±50 | mA |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current | - | ±50 | mA | |
| T _{STG} | Storage Temperature Range | -65 | +150 | °C | |
| T_J | Junction Temperature Under Bias | | - | +150 | °C |
| T_L | Junction Lead Temperature (Solde | ering, 10 Seconds) | - | +260 | °C |
| P_{D} | Power Dissipation in Still Air | SC-74A / SOT23-5 | - | 390 | mW |
| | | SC-88A | - | 332 | |
| | | MicroPak-6 | - | 812 | |
| | | MicroPak2™-6 | - | 812 | |
| ESD | Human Body Model, JESD22-A1 | 14 | - | 4000 | V |
| | Charge Device Model, JESD22-C | C101 | - | 2000 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------------------|-------------------------------|--|------|-----------------|------|
| V _{CC} | Supply Voltage Operating | | 1.65 | 5.50 | V |
| | Supply Voltage Data Retention | | 1.50 | 5.50 | |
| V _{IN} | Input Voltage | | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | | 0 | V _{CC} | V |
| T _A | Operating Temperature | | -40 | +85 | °C |
| t _r , t _f | Input Rise and Fall Times | V _{CC} at 1.8 V, 2.5 V ±0.2 V | 0 | 20 | ns/V |
| | | V _{CC} at 3.3 V ±0.3 V | 0 | 10 | |
| | | V _{CC} at 5.0 V ±0.5 V | 0 | 5 | |
| $\theta_{\sf JA}$ | Thermal Resistance | SC-74A / SOT23-5 | - | 320 | °C/W |
| | | SC-88A | - | 377 | |
| | | MicroPak-6 | - | 154 | |
| | | MicroPak2-6 | - | 154 | |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

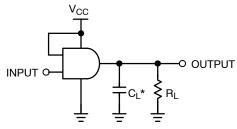
DC ELECTICAL CHARACTERISTICS

| | | | | T _A = +25°C | | °C | $T_A = -40$ | to +85°C | |
|------------------|---------------------------|---------------------|---|------------------------|------|----------------------|----------------------|----------------------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit |
| V _{IH} | HIGH Level Input Voltage | 1.65 to 1.95 | | 0.65 V _{CC} | - | - | 0.65 V _{CC} | - | V |
| | | 2.30 to 5.50 | | 0.70 V _{CC} | _ | - | 0.70 V _{CC} | - | |
| V_{IL} | LOW Level Input Voltage | 1.65 to 1.95 | | - | _ | 0.35 V _{CC} | - | 0.35 V _{CC} | ٧ |
| | | 2.30 to 5.50 | | - | _ | 0.30 V _{CC} | - | 0.30 V _{CC} | |
| V _{OH} | HIGH Level Output Voltage | 1.65 | $V_{IN} = V_{IH}$ or V_{IL} , | 1.55 | 1.65 | - | 1.55 | - | V |
| | | 1.80 | I _{OH} = -100 μA | 1.70 | 1.80 | - | 1.70 | - | |
| | | 2.30 | | 2.20 | 2.30 | - | 2.20 | - | |
| | | 3.00 | | 2.90 | 3.00 | - | 2.90 | - | |
| | | 4.50 | | 4.40 | 4.50 | - | 4.40 | - | |
| | | 1.65 | I _{OH} = -4 mA | 1.29 | 1.52 | - | 1.29 | - | |
| | | 2.30 | I _{OH} = -8 mA | 1.90 | 2.15 | - | 1.90 | - | |
| | | 3.00 | I _{OH} = -16 mA | 2.50 | 2.80 | - | 2.40 | - | |
| | | 3.00 | I _{OH} = -24 mA | 2.40 | 2.68 | - | 2.30 | - | 1 |
| | | 4.50 | I _{OH} = -32 mA | 3.90 | 4.20 | - | 3.80 | - | 1 |
| V _{OL} | LOW Level Output Voltage | 1.65 | $V_{IN} = V_{IH} \text{ or } V_{IL},$ | _ | 0.00 | 0.10 | - | 0.10 | V |
| | | 1.80 | I _{OL} = 100 μA | - | 0.00 | 0.10 | - | 0.10 | 1 |
| | | 2.30 | | _ | 0.00 | 0.10 | - | 0.10 | |
| | | 3.00 | | _ | 0.00 | 0.10 | - | 0.10 | |
| | | 4.50 | | _ | 0.00 | 0.10 | - | 0.10 | |
| | | 1.65 | I _{OL} = 4 mA | - | 0.80 | 0.24 | - | 0.24 | |
| | | 2.30 | I _{OL} = 8 mA | - | 0.10 | 0.30 | - | 0.30 | |
| | | 3.00 | I _{OL} = 16 mA | _ | 0.15 | 0.40 | - | 0.40 | |
| | | 3.00 | I _{OL} = 24 mA | - | 0.22 | 0.55 | - | 0.55 | |
| | | 4.50 | I _{OL} = 32 mA | - | 0.22 | 0.55 | - | 0.55 |] |
| I _{IN} | Input Leakage Current | 1.65 to 5.50 | V _{IN} = 5.5 V, GND | - | _ | ±1 | - | ±10 | μΑ |
| I _{OFF} | Power Off Leakage Current | 0 | V _{IN} or V _{OUT} = 5.5 V | - | - | 1 | - | 10 | μΑ |
| I _{CC} | Quiescent Supply Current | 1.65 to 5.50 | V _{IN} = 5.5 V, GND | - | _ | 2 | - | 20 | μА |

AC ELECTRICAL CHARACTERISTICS

| | | | | 7 | Γ _A = +25°C | ; | T _A = -40 | to +85°C | |
|-------------------------------------|---|---------------------|-------------------------|-----|------------------------|------|----------------------|----------|------|
| Symbol | Parameter | V _{CC} (V) | Conditions | Min | Тур | Max | Min | Max | Unit |
| t _{PLH} , t _{PHL} | Propagation Delay | 1.65 | C _L = 15 pF, | - | 6.3 | 12.0 | - | 12.7 | ns |
| | (Figure 4, 5) | 1.80 | $R_L = 1 M\Omega$ | = | 5.2 | 10.0 | - | 10.5 | |
| | | 2.50 ±0.20 | | = | 3.4 | 7.0 | - | 7.5 | |
| | | 3.30 ±0.30 | | = | 2.6 | 4.7 | - | 5.0 | |
| | | 5.00 ±0.50 | | = | 2.2 | 4.1 | - | 4.4 | |
| | | 3.30 ±0.30 | C _L = 50 pF, | - | 3.3 | 5.2 | - | 5.5 | |
| | | 5.00 ±0.50 | $R_L = 500 \Omega$ | _ | 2.7 | 4.5 | - | 4.8 | |
| C _{IN} | Input Capacitance | 0.00 | | - | 4 | - | - | _ | pF |
| C _{PD} | C _{PD} Power Dissipation Capacitance | 3.30 | | - | 20 | - | - | _ | pF |
| | (Note 2) (Figure 6) | 5.00 | | - | 25 | - | - | - | |

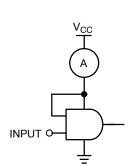
2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).$



NOTE:

- 3. CL includes load and stray capacitance.
 4. Input PRR = 10 MHz t_w = 500 ns.

Figure 4. AC Test Circuit



NOTE:

5. Input = AC Waveform; $t_r = t_f = 1.8 \text{ ns}$; PRR = 10 MHz; Duty Cycle = 50%.

Figure 6. I_{CCD} Test Circuit

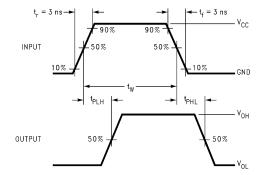


Figure 5. AC Waveforms

ORDERING INFORMATION

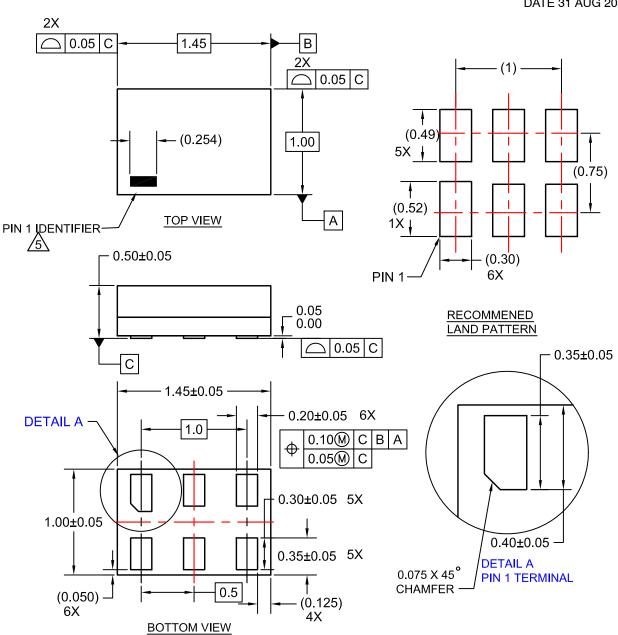
| Part Number | Top Mark | Packages | Shipping [†] |
|-------------------|----------|------------------|-----------------------|
| NC7SZ08M5X | 7Z08 | SC-74A | 3000 / Tape & Reel |
| NC7SZ08M5X-L22090 | 7Z08 | SOT23-5 | 3000 / Tape & Reel |
| NC7SZ08P5X | Z08 | SC-88A | 3000 / Tape & Reel |
| NC7SZ08P5X-F22057 | Z08 | SC-88A | 3000 / Tape & Reel |
| NC7SZ08L6X | GG | SIP6, MicroPak | 5000 / Tape & Reel |
| NC7SZ08L6X-L22175 | GG | SIP6, MicroPak | 5000 / Tape & Reel |
| NC7SZ08FHX | GG | UDFN6, MicroPak2 | 5000 / Tape & Reel |
| NC7SZ08FHX-L22175 | GG | UDFN6, MicroPak2 | 5000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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DATE 31 AUG 2016



NOTES:

- 1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
 4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

 - OTHER LINE IN THE MARK CODE LAYOUT.

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| DESCRIPTION: | SIP6 1.45X1.0 | | PAGE 1 OF 1 | | |

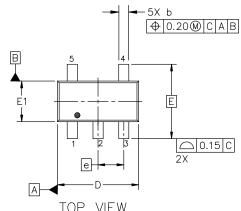
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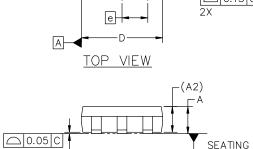




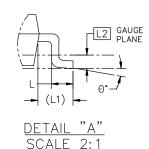
SC-74A-5 3.00x1.50x0.95, 0.95P CASE 318BQ ISSUE C

DATE 26 FEB 2024





SIDE VIEW



PLANE

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

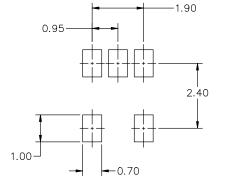
NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- 2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
 BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.

| | \ |
|----------|---|
| END VIEW | |

| DIM | | | | |
|-------|-----------|----------|------|--|
| DIIVI | MIN. | NOM. | MAX. | |
| Α | 0.90 | 1.00 | 1.10 | |
| A1 | 0.01 | 0.18 | 0.10 | |
| A2 | (| 0.95 REF | | |
| b | 0.25 | 0.37 | 0.50 | |
| С | 0.10 | 0.18 | 0.26 | |
| D | 2.85 | 3.00 | 3.15 | |
| Е | : | 2.75 BSC | ; | |
| E1 | 1.35 | 1.50 | 1.65 | |
| е | | 0.95 BSC | ; | |
| L | 0.20 | 0.40 | 0.60 | |
| L1 | 0.62 REF. | | | |
| L2 | | 0.25 BSC | | |
| Θ | 0, | 5* | 10° | |

MILLIMETERS



RECOMMENDED MOUNTING FOOTPRINT*

* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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|------------------|--------------------------|---|-------------|
| DESCRIPTION: | SC-74A-5 3.00x1.50x0.95. | 0.95P | PAGE 1 OF 1 |

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SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

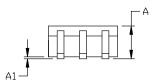
DATE 11 APR 2023

NOTES:

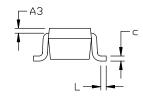
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. 419A-01 DBSOLETE, NEW STANDARD 419A-02
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,
 OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

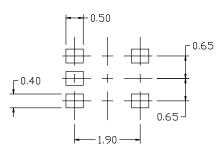
| DIM | MILLIMETERS | | | | |
|-------|-------------|----------|------|--|--|
| ואונת | MIN. | N□M. | MAX. | | |
| А | 0.80 | 0.95 | 1.10 | | |
| A1 | | | 0.10 | | |
| A3 | | 0.20 REF | • | | |
| b | 0.10 | 0.20 | 0.30 | | |
| C | 0.10 | | 0.25 | | |
| D | 1.80 | 2.00 | 2,20 | | |
| Е | 2.00 | 2.10 | 2.20 | | |
| E1 | 1.15 | 1.25 | 1.35 | | |
| е | | 0.65 BSI | | | |
| L | 0.10 | 0.15 | 0.30 | | |

E + E1



→ 0.2 M B M





RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

| STYLE 1: |
|-----------------------------|
| PIN 1. BASE |
| EMITTER |
| 3. BASE |
| COLLECTOR |
| COLLECTOR |
| |

| YLE 2 | 2: |
|-------|-----------|
| IN 1. | ANODE |
| 2. | EMITTER |
| 3. | BASE |
| 4. | COLLECTOR |
| 5. | CATHODE |
| | |

STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1 STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2

STYLE 5:
PIN 1. CATHODE
2. COMMON ANODE
3. CATHODE 2
4. CATHODE 3
5. CATHODE 4

STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR STYLE 7:
PIN 1. BASE
2. EMITTER
3. BASE
4. COLLECTOR
5. COLLECTOR

STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE

5. EMITTER

STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

DOCUMENT NUMBER:

98ASB42984B

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DESCRIPTION:

5. COLLECTOR 2/BASE 1

SC-88A (SC-70-5/SOT-353)

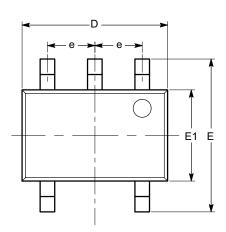
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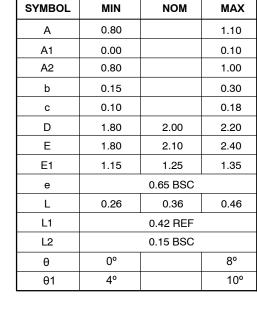


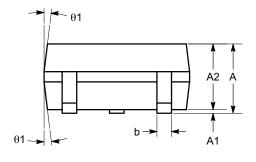
SC-88A (SC-70 5 Lead), 1.25x2 CASE 419AC-01 ISSUE A

DATE 29 JUN 2010

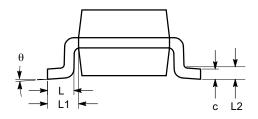


TOP VIEW





SIDE VIEW



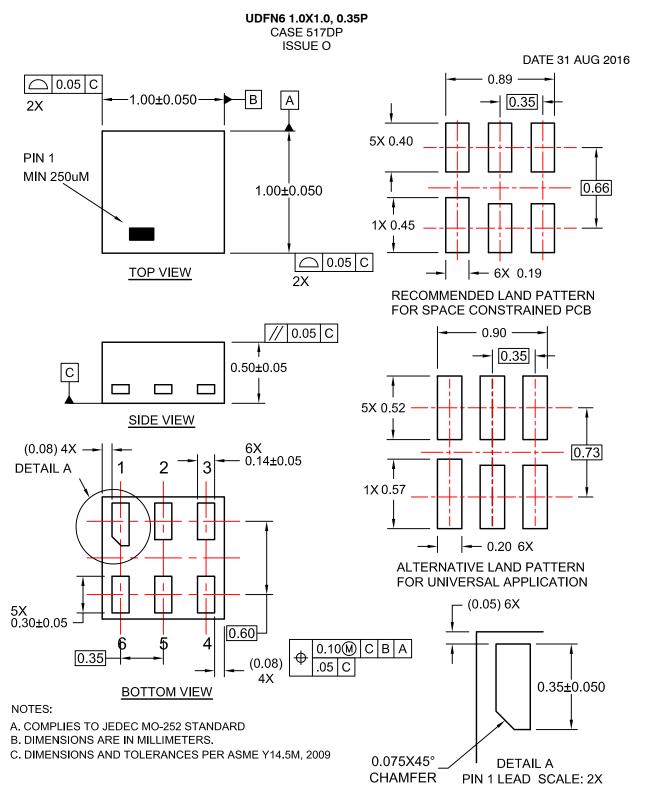
END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

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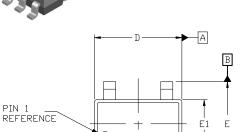
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| DESCRIPTION: | UDFN6 1.0X1.0, 0.35P | | PAGE 1 OF 1 |

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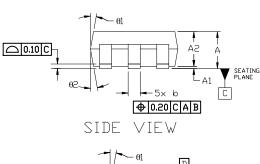


SOT-23, 5 Lead CASE 527AH **ISSUE A**

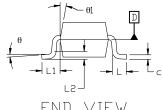
DATE 09 JUN 2021

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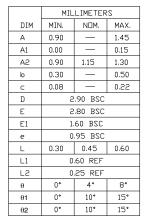
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS, MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
- DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL BE O. 08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.

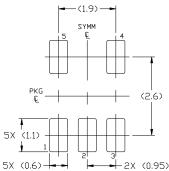


TOP VIEW



END VIEW





GENERIC MARKING DIAGRAM*



XXX = Specific Device Code = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the $\square N$ Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|----------------|--|-------------|
| DESCRIPTION: | SOT-23, 5 LEAD | | PAGE 1 OF 1 |

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